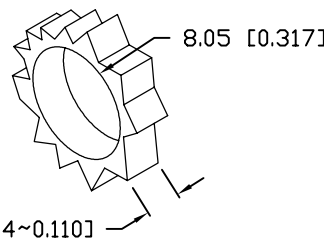


PANEL CUTOUT



ELECTRO-OPTICAL CHARACTERISTICS $T_A=25^{\circ}\text{C}$ $I_f=20\text{mA}$

| PARAMETER | MIN | TYP | MAX | UNITS | TEST COND |
|--------------------|-----------------|-----|-----|----------|----------------------|
| PEAK WAVELENGTH | | 590 | | nm | |
| FORWARD VOLTAGE | | 2.1 | 2.5 | V_f | |
| REVERSE VOLTAGE | 5.0 | | | V_r | $I_r=100\mu\text{A}$ |
| AXIAL INTENSITY | | 300 | | mcd | $I_f=20\text{mA}$ |
| VIEWING ANGLE | | 60 | | 2x theta | |
| EMITTED COLOR: | YELLOW | | | | |
| EPOXY LENS FINISH: | YELLOW DIFFUSED | | | | |

LIMITS OF SAFE OPERATION AT 25°C

| PARAMETER | MAX | UNITS |
|----------------------------------|------------|------------------------|
| PEAK FORWARD CURRENT* | 150 | mA |
| STEADY CURRENT | 30 | mA |
| POWER DISSIPATION | 105 | mW |
| DERATE FROM 25°C | -1.2 | mW/ $^{\circ}\text{C}$ |
| OPERATING, STORAGE TEMP. | -40 TO +85 | $^{\circ}\text{C}$ |
| SOLDERING TEMP. | +260 | $^{\circ}\text{C}$ |
| 2.0mm FROM BODY | | 3 SEC. MAX |

* $t < 10\mu\text{s}$

NOTES:

1. SSL-LX5093SYD, YELLOW LED.
2. SSH-RTF5010, BLACK HOLDER.



*UNLESS OTHERWISE SPECIFIED TOLERANCES PER DECIMAL PRECISION ARE: X=±1 (±0.039), X.X=±0.5 (±0.020), X.XX=±0.25 (±0.010), X.XXX=±0.127 (±0.005). LEAD SIZE=±0.05 (±0.002), LEAD LENGTH=±0.75 (±0.030). MIN.= +DECIMAL PRECISION -0.00, MAX.= +0.00 -DECIMAL PRECISION

| | |
|------|-------------------------------|
| REV. | PART NUMBER SSI-LXR5010SYD |
|------|-------------------------------|

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T-5mm 590nm SUPER YELLOW LED PANEL INDICATOR,
YELLOW DIFFUSED LENS.

RELIABILITY NOTE
OUR MANY YEARS OF EXPERIENCE DATA ACCUMULATION INDICATE THAT SOLDER HEAT IS A MAJOR CAUSE OF EARLY AND FUTURE FAILURE. PLEASE PAY ATTENTION TO YOUR SOLDERING PROCESS.

| | | | |
|-----------------|-------------------|--------------------|--|
| DRAWN BY: JN | CHECKED BY: JD | APPROVED BY: JD | DATE: 05.20.08 PAGE: 1 OF 1 SCALE: N/A |
|-----------------|-------------------|--------------------|--|